P-Channel Enhancement-Mode Vertical DMOS FET

Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{ISS} and fast switching speeds
- High input impedance and high gain
- Excellent thermal stability
- Integral source-to-drain diode

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

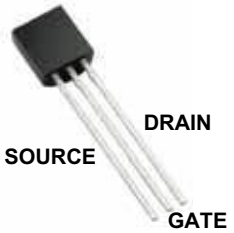
Part Number	Package Option	Packing
VP3203N3-G	3-Lead TO-92	1000/Bag
VP3203N3-G P002	3-Lead TO-92	2000/Reel
VP3203N3-G P003		
VP3203N3-G P005		
VP3203N3-G P013		
VP3203N3-G P014		
VP3203N3-G	TO-243AA (SOT-89)	2000/Reel

-G denotes a lead (Pb)-free / RoHS compliant package.
Contact factory for Wafer / Die availablity.
Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

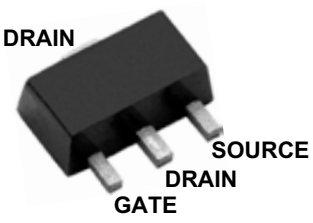
Product Summary

BV_{DSS}/BV_{DGS}	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)
-30V	0.6Ω	-4.0A

Pin Configuration



TO-92



TO-243AA (SOT-89)

Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV_{DSS}
Drain-to-gate voltage	BV_{DGS}
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Typical Thermal Resistance

Package	θ_{ja}
TO-92	132°C/W
TO-243AA (SOT-89)	133°C/W

Product Marking

YY = Year Sealed
WW = Week Sealed
_____ = "Green" Packaging

Package may or may not include the following marks: Si or ⏻

TO-92

W = Code for week sealed
_____ = "Green" Packaging

Package may or may not include the following marks: Si or ⏻

TO-243AA (SOT-89)

Thermal Characteristics

Package	I_D (continuous)†	I_D (pulsed)	Power Dissipation @T_A = 25°C	I_{DR}†	I_{DRM}
TO-92	-650mA	-4.0A	0.74W	-650mA	-4.0A
TO-243AA (SOT-89)	-1100mA	-4.0A	1.6‡	-1100mA	-4.0A

† *I_D (continuous) is limited by max rated T_j.*
‡ *Mounted on FR5 board, 25mm x 25mm x 1.57mm.*

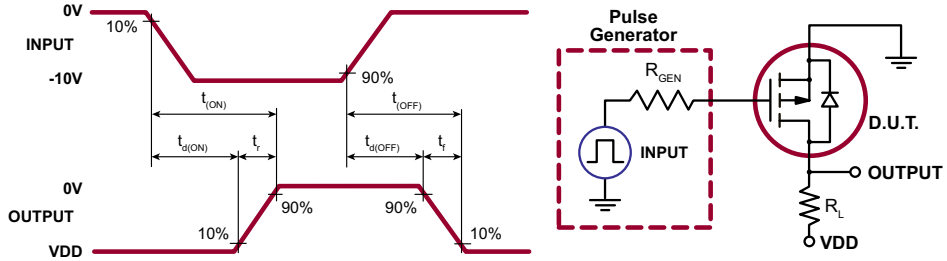
Electrical Characteristics *(T_A = 25°C unless otherwise specified)*

Sym	Parameter		Min	Typ	Max	Units	Conditions
BV_{DSS}	Drain-to-source breakdown voltage		-30	-	-	V	V_{GS} = 0V, I_D = -10mA
$V_{GS(th)}$	Gate threshold voltage		-1.0	-	-3.5	V	V_{GS} = V_{DS}, I_D= -10mA
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature		-	-	-5.5	mV/°C	V_{GS} = V_{DS}, I_D= -10mA
I_{GSS}	Gate body leakage		-	-1.0	-100	nA	V_{GS} = ± 20V, V_{DS} = 0V
I_{DSS}	Zero gate voltage drain current		-	-	-10	µA	V_{GS} = 0V, V_{DS} = Max Rating
			-	-	-1.0	mA	V_{DS} = 0.8 Max Rating, V_{GS} = 0V, T_A = 125°C
$I_{D(ON)}$	On-state drain current		-	-14	-	A	V_{GS} = -10V, V_{DS} = -5.0V
$R_{DS(ON)}$	Static drain-to-source on-state resistance	TO-92	-	-	1.0	Ω	V_{GS} = -4.5V, I_D = -1.5A
		SOT-89	-	-	1.0		V_{GS} = -4.5V, I_D = -750mA
		TO-92	-	-	0.6		V_{GS} = -10V, I_D = -3.0A
		SOT-89	-	-	0.6		V_{GS} = -10V, I_D = -1.5A
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature		-	-	1.0	%/°C	V_{GS} = -10V, I_D = -1.5A
G_{FS}	Forward transductance		1000	2000	-	mmho	V_{DS} = -25V, I_D = -2.0A
C_{ISS}	Input capacitance		-	200	300	pF	V_{GS} = 0V, V_{DS} = -25V, f = 1.0MHz
C_{OSS}	Common source output capacitance		-	100	120		
C_{RSS}	Reverse transfer capacitance		-	45	60		
$t_{d(ON)}$	Turn-on delay time		-	-	10	ns	V_{DD} = -25V, I_D = -2.0A, R_{GEN} = 10Ω
t_r	Rise time		-	-	15		
$t_{d(OFF)}$	Turn-off delay time		-	-	25		
t_f	Fall time		-	-	25		
V_{SD}	Diode forward voltage drop		-	-	-1.6	V	V_{GS} = 0V, I_{SD} = -1.5A
t_{rr}	Reverse recovery time		-	300	-	ns	V_{GS} = 0V, I_{SD} = -1.0A

Notes:

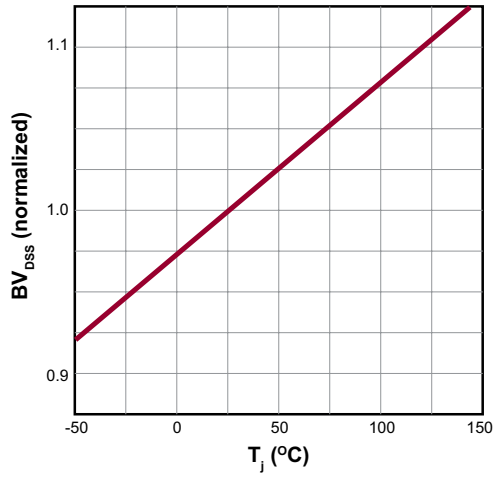
1. *All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)*
2. *All A.C. parameters sample tested.*

Switching Waveforms and Test Circuit

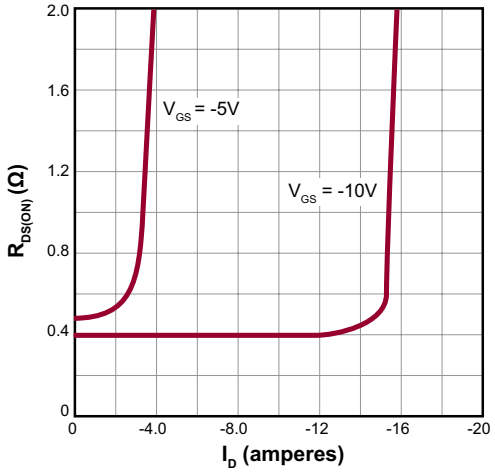


Typical Performance Curves

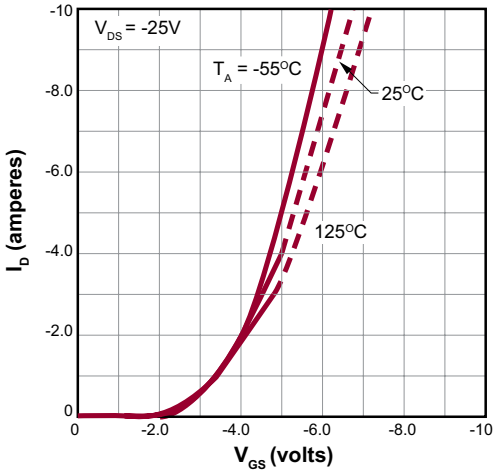
BV_{DSS} Variation with Temperature



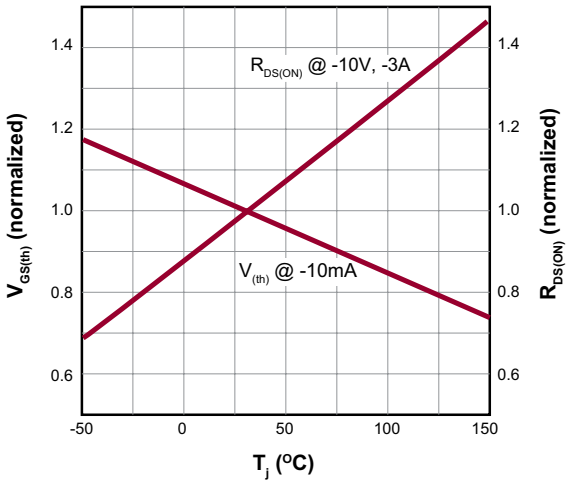
On-Resistance vs. Drain Current



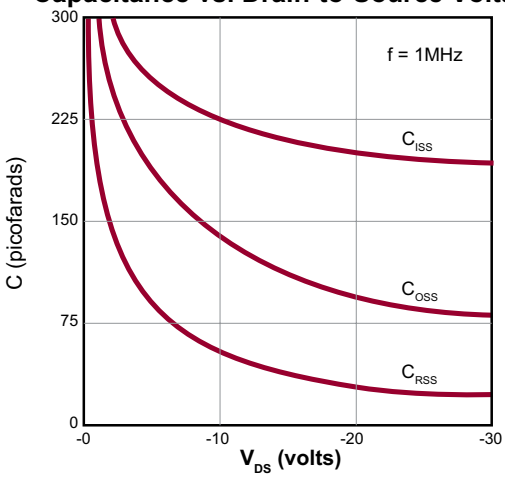
Transfer Characteristics



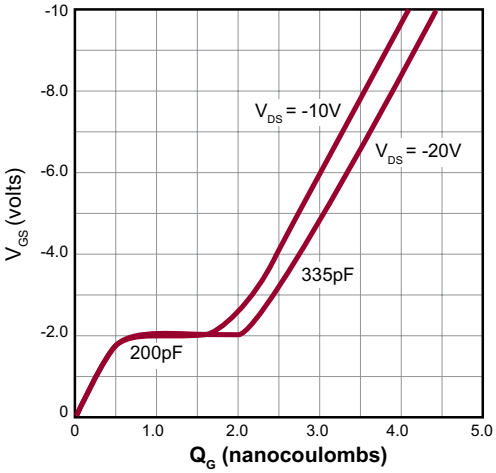
$V_{(th)}$ and R_{DS} Variation with Temperature



Capacitance vs. Drain-to-Source Voltage

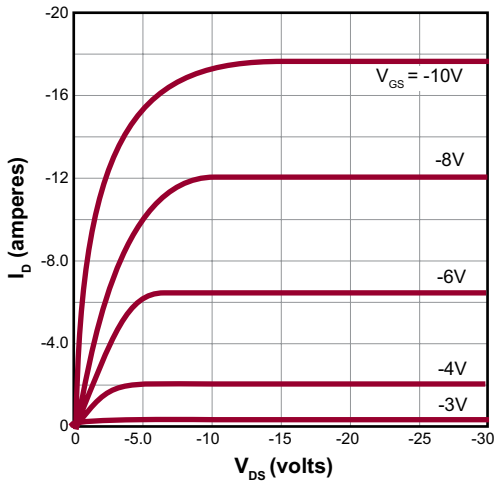


Gate Drive Dynamic Characteristics

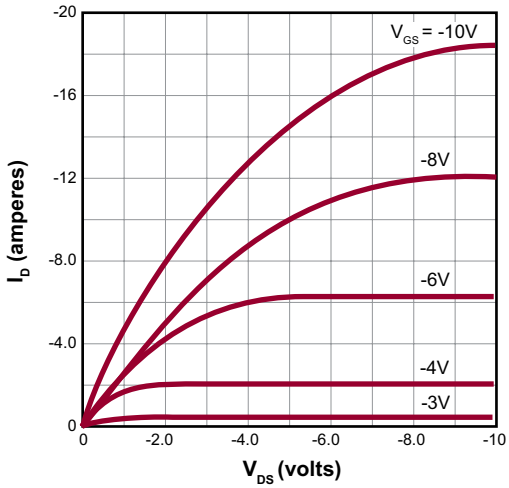


Typical Performance Curves *(cont.)*

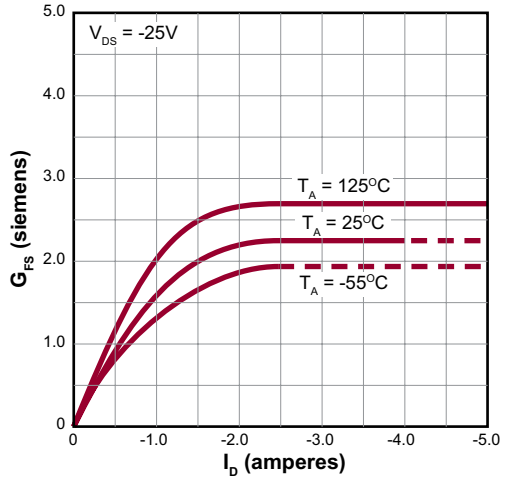
Output Characteristics



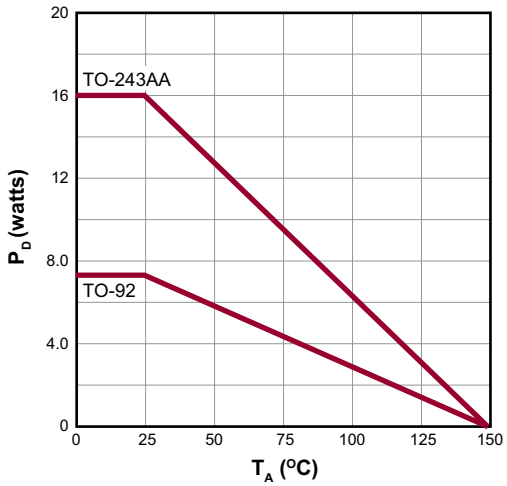
Saturation Characteristics



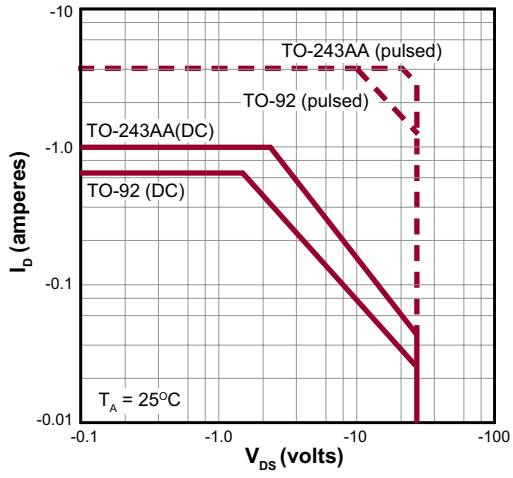
Transconductance vs. Drain Current



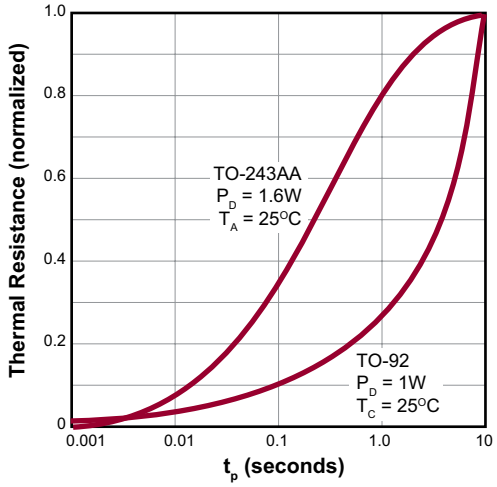
Power Dissipation vs. Ambient Temperature



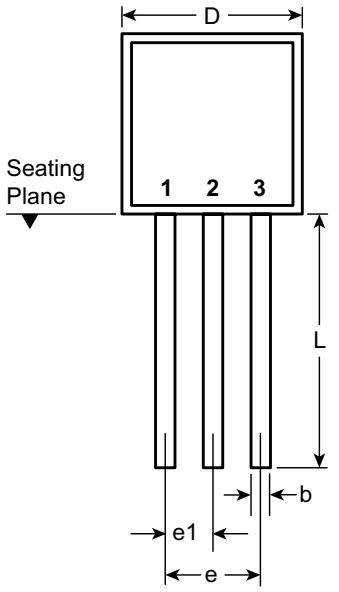
Maximum Rated Safe Operating Area



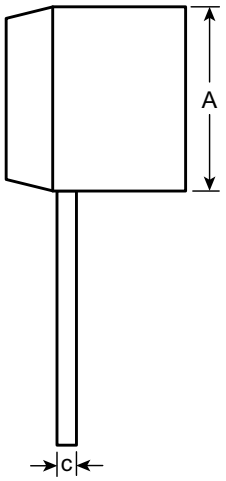
Thermal Response Characteristics



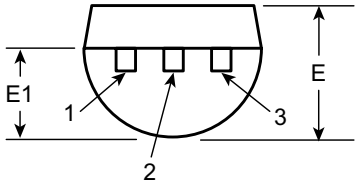
3-Lead TO-92 Package Outline (N3)



Front View



Side View

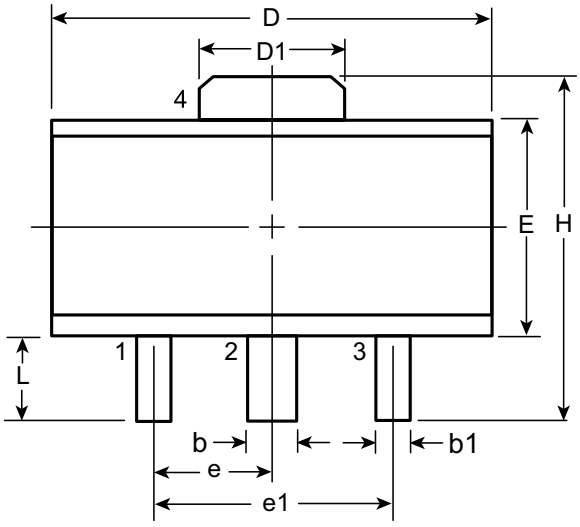


Bottom View

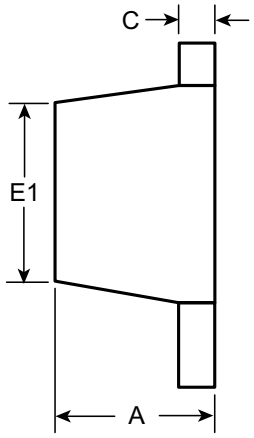
Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014†	.014†	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022†	.022†	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.
** This dimension is not specified in the JEDEC drawing.*
† This dimension differs from the JEDEC drawing.
Drawings not to scale.
***Supertex Doc.#:** DSPD-3TO92N3, Version E041009.*

3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View



Side View

Symbol		A	b	b1	C	D	D1	E	E1	e	e1	H	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00†	1.50 BSC	3.00 BSC	3.94	0.73†
	NOM	-	-	-	-	-	-	-	-			-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.
† *This dimension differs from the JEDEC drawing*
Drawings not to scale.
Supertex Doc. #: *DSPD-3TO243AAN8, Version F111010.*

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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